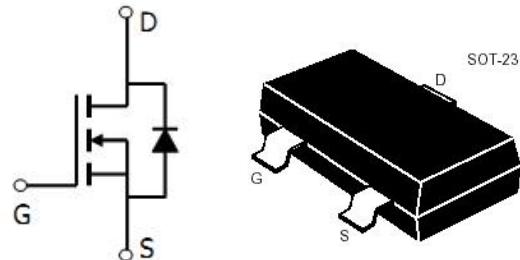


MMBF170

SOT-23 場效應晶體管(SOT-23 Field Effect Transistors)



### N-Channel Enhancement-Mode MOS FETs

N 溝道增強型 MOS 場效應管

#### ■MAXIMUM RATINGS 最大額定值

| Characteristic 特性參數                     | Symbol 符號  | Rat 額定值  | Unit 單位 |
|---|------------|----------|---------|
| Drain-Source Voltage<br>漏極-源極電壓         | $BV_{DSS}$ | 60       | V       |
| Gate- Source Voltage<br>柵極-源極電壓         | $V_{GS}$   | $\pm 20$ | V       |
| Drain Current (continuous)<br>漏極電流 - 連續 | $I_{DR}$   | 500      | mA      |
| Drain Current (pulsed)<br>漏極電流 - 脉冲     | $I_{DRM}$  | 800      | mA      |

#### ■THERMAL CHARACTERISTICS 热特性

| Characteristic 特性   | Symbol 符號       | Max 最大值              | Unit 單位                    |
|---|-----------------|----------------------|----------------------------|
| Total Device Dissipation 總耗散功率<br>$T_A=25^\circ\text{C}$ 環境溫度為 $25^\circ\text{C}$ | $P_D$           | 225                  | mW                         |
| Derate above $25^\circ\text{C}$ 超過 $25^\circ\text{C}$ 遞減                          |                 | 1.8                  | $\text{mW}/^\circ\text{C}$ |
| Thermal Resistance Junction to Ambient 热阻   | $R_{\theta JA}$ | 417                  | $^\circ\text{C}/\text{W}$  |
| Junction and Storage Temperature<br>結溫和儲存溫度                                       | $T_J, T_{stg}$  | 150°C, -55 to +150°C |                            |



MMBF170

**■DEVICE MARKING 打標**

MMBF170=6Z

**■ELECTRICAL CHARACTERISTICS 電特性**(T<sub>A</sub>=25°C unless otherwise noted 如無特殊說明，溫度為 25°C)

| Characteristic<br>特性參數  | Symbol<br>符號        | Min<br>最小值 | Typ<br>典型值 | Max<br>最大值    | Unit<br>單位 |
|---|---------------------|------------|------------|---------------|------------|
| Drain-Source Breakdown Voltage<br>漏極-源極擊穿電壓(I <sub>D</sub> =100uA, V <sub>GS</sub> =0V)   | BVDSS               | 60         | —          | —             | V          |
| Gate Threshold Voltage<br>柵極開启電壓(I <sub>D</sub> =1mA, V <sub>GS</sub> = V <sub>DS</sub> )   | V <sub>GS(th)</sub> | 0.8        | —          | 3             | V          |
| Drain-Source On Voltage<br>漏極-源極導通電壓(I <sub>D</sub> =50mA, V <sub>GS</sub> =5V)<br>(I <sub>D</sub> =500mA, V <sub>GS</sub> =10V)                                    | V <sub>DS(ON)</sub> | —          | —          | 0.375<br>3.75 | V          |
| Diode Forward Voltage Drop<br>內附二極管正向壓降(I <sub>SD</sub> =200mA, V <sub>GS</sub> =0V)  | V <sub>SD</sub>     | —          | —          | 1.5           | V          |
| Zero Gate Voltage Drain Current<br>零柵壓漏極電流(V <sub>GS</sub> =0V, V <sub>DS</sub> = BVDSS)<br>(V <sub>GS</sub> =0V, V <sub>DS</sub> =0.8BVDSS, T <sub>A</sub> =125°C) | I <sub>DSS</sub>    | —          | —          | 1<br>500      | uA         |
| Gate Body Leakage<br>柵極漏電流(V <sub>GS</sub> =±15V, V <sub>DS</sub> =0V)  | I <sub>GSS</sub>    | —          | —          | ±10           | nA         |
| Static Drain-Source On-State Resistance<br>静态漏源導通電阻<br>(I <sub>D</sub> =200mA, V <sub>GS</sub> =10V)  | R <sub>DS(ON)</sub> | —          | —          | 5             | Ω          |
| Input Capacitance 輸入電容<br>(V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz)   | C <sub>ISS</sub>    | —          | —          | 60            | pF         |
| Common Source Output Capacitance<br>共源輸出電容(V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz)   | C <sub>OSS</sub>    | —          | —          | 25            | pF         |
| Turn-ON Time 开启時間<br>(V <sub>DS</sub> =30V, I <sub>D</sub> =200mA, R <sub>GEN</sub> =25Ω)   | t <sub>(on)</sub>   | —          | —          | 20            | ns         |
| Turn-OFF Time 短斷時間<br>(V <sub>DS</sub> =30V, I <sub>D</sub> =200mA, R <sub>GEN</sub> =25Ω)  | t <sub>(off)</sub>  | —          | —          | 40            | ns         |
| Reverse Recovery Time 反向恢复時間<br>(I <sub>SD</sub> =800mA, V <sub>GS</sub> =0V)   | t <sub>rr</sub>     | —          | 400        | —             | ns         |

1. FR-5=1.0×0.75×0.062in.
2. Alumina=0.4×0.3×0.024in. 99.5%alumina.
3. Pulse Width≤300 μ s; Duty Cycle≤2.0%.